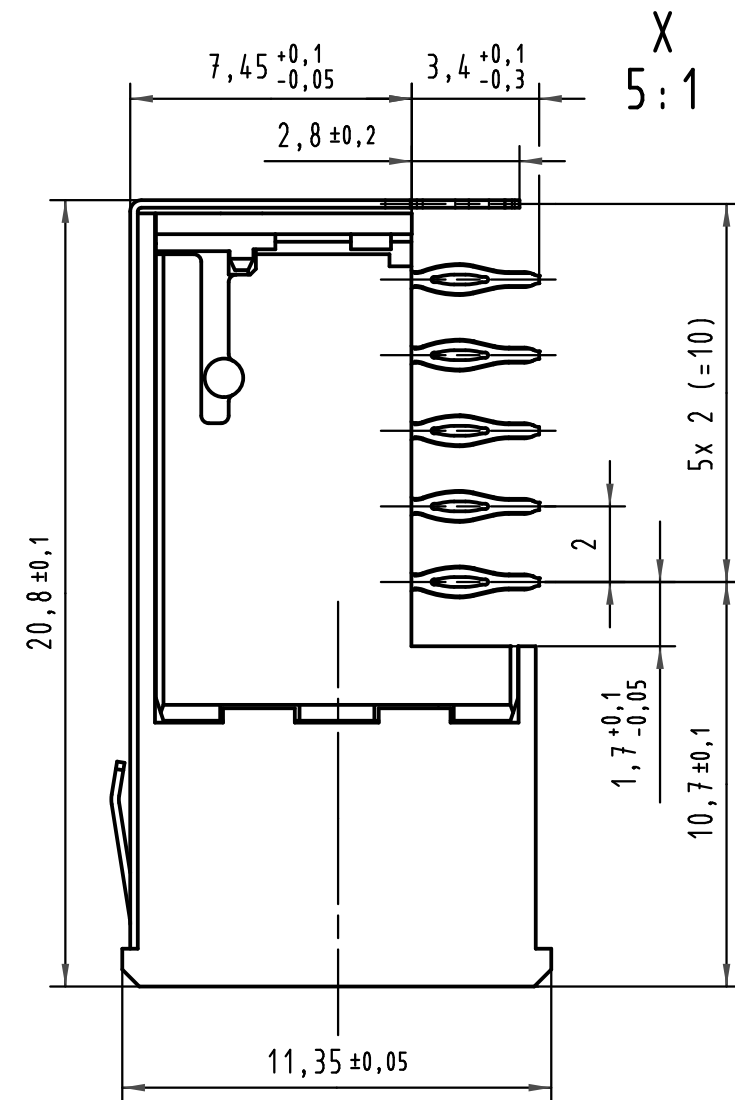
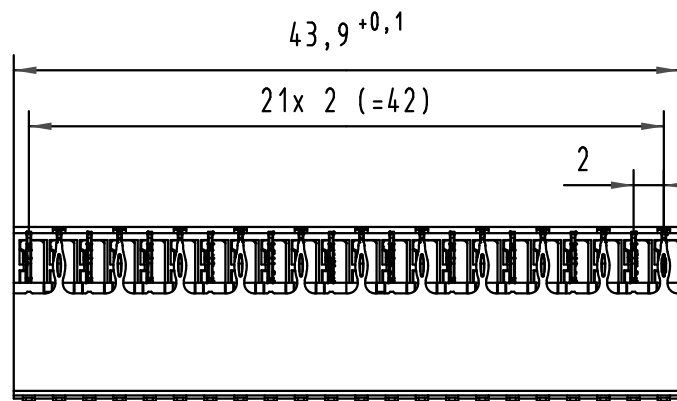
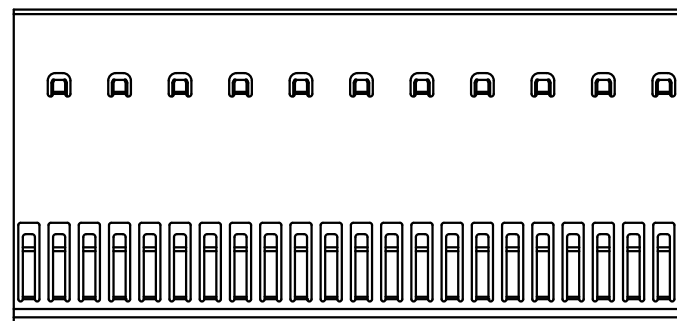
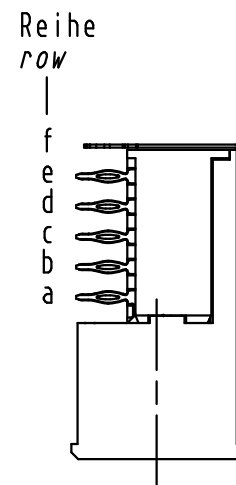
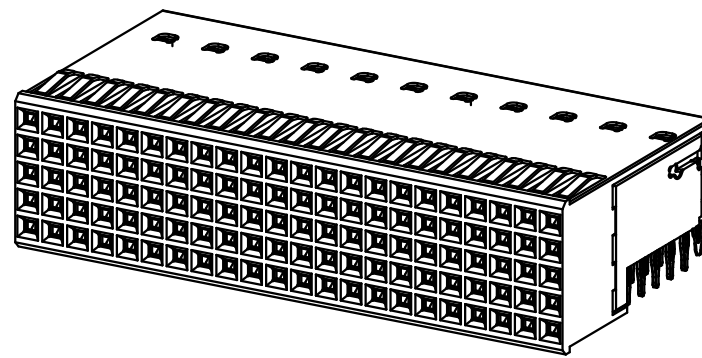
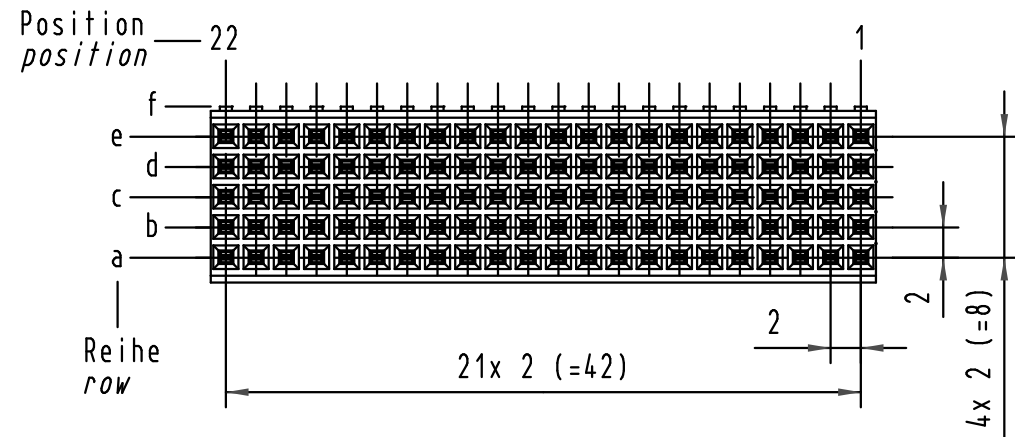
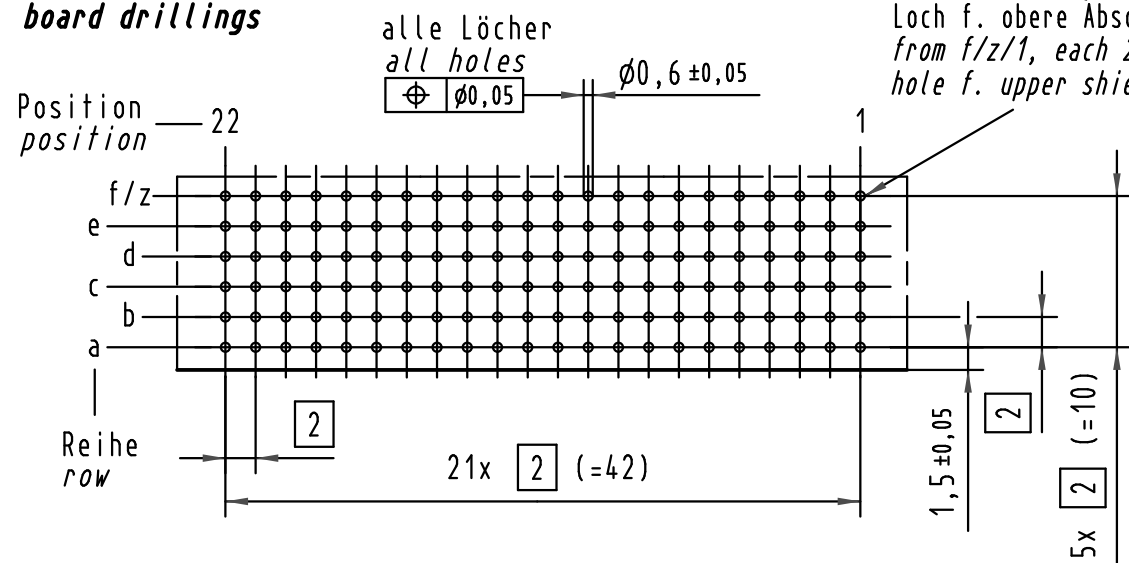




Lochbild board drillings



Bohrlochdurchmesser: $\varnothing 0,7 \pm 0,02$ mm
Lochdurchmesser (mit Oberfläche): $\varnothing 0,6 \pm 0,05$ mm
drill hole dia.: $\varnothing 0,7 \pm 0,02$ mm
through hole dia. (after plating): $\varnothing 0,6 \pm 0,05$ mm

17 24 110 4102	—	min.0,76µm (30µin) Au über/over min.1,27µm (50µin) Ni
17 24 110 2102	2	Au über/over Ni
17 24 110 1102	1	Au über/over Ni
Bestell-Nr. part-No.	Anforderungsstufe nach IEC performance level acc. to IEC	Kontaktoberfläche contact plating

 All Dimensions in mm Original Size DIN A 3			Techn. Character.				Nicht tolerierte Maß/Free size tolerances IEC 61076-4-101	
				Dat.	Name	Maßstab/Scale 2:1 (5:1)	har-bus HM Federleiste, Typ B-22, 110 pol. mit Schirmblech Reihe-f <i>har-bus HM female connector, type B-22, 110 pol. with shield row-f</i>	
35456	01.12.08	TD	Detail.	30.06.99	Hm			
32387	18.11.04	HL.	Insp.	30.06.99	Ko			
29412	07.05.01	Lk	Stand.					
28494	20.09.00	Koe	HARTING Electronics GmbH & Co. KG D-32339 ESPELKAMP				TB 17 24 110 x102	Blatt/ page /
25016								
Mod.	Dat.	Name	Sub.					